



Let Performance Drive

CMD195C3

DC-18 GHz SPDT Non-reflective Switch

Features

- ▶ Positive gain slope
- ▶ High isolation
- ▶ Non-reflective design
- ▶ Pb-free RoHs compliant 3x3 SMT package

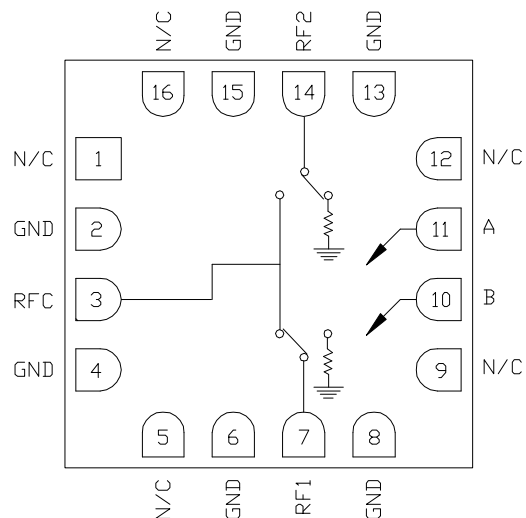
Applications

- ▶ Microwave radio and VSAT
- ▶ Telecom infrastructure
- ▶ Test instrumentation
- ▶ Military end-use

Description

The CMD195C3 is a broadband MMIC SPDT switch housed in a leadless 3x3 mm surface mount package. The CMD195C3 covers DC to 18 GHz and offers a low insertion loss of 2 dB and high isolation of 37 dB as well as positive gain slope. The positive gain slope feature allows for several switches to be cascaded together without the need for gain equalization circuitry. The CMD195C3 operates using complementary control voltage logic lines of 0/-5 V and requires no bias supply.

Functional Block Diagram



Electrical Performance - $V_{ctl} = 0/-5\text{ V}$, $T_A = 25\text{ }^\circ\text{C}$, $F = 18\text{ GHz}$

| Parameter | Min | Typ | Max | Units |
|----------------------------------|---------|-----|-----|-------|
| Frequency Range | DC - 18 | | | GHz |
| Insertion Loss | | 2 | | dB |
| Isolation | | 37 | | dB |
| Return Loss - On State | | 13 | | dB |
| Return Loss RF1, RF2 - Off State | | 11 | | dB |
| Input P1dB | | 25 | | dBm |
| Switching Speed | | 1.8 | | ns |

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Specifications

Absolute Maximum Ratings

| Parameter | Rating |
|--------------------------------------|----------------|
| RF Input Power | +27 dBm |
| Control Voltage Range (A,B) | +0.5V to -7.5V |
| Channel Temperature, T _{ch} | 150 °C |
| Operating Temperature | -40 to 85 °C |
| Storage Temperature | -55 to 150 °C |

Operation of this device outside the maximum ratings may cause permanent damage.

Control Voltages

| State | Bias Condition |
|-------|----------------------------------|
| Low | 0 to -0.5V @ 1 uA Typ |
| High | -5V @ 1 uA Typ to -7V @ 6 uA Typ |

Truth Table

| Control Input | | Signal Path State | |
|---------------|------|-------------------|------------|
| A | B | RFC to RF1 | RFC to RF2 |
| High | Low | On | Off |
| Low | High | Off | On |

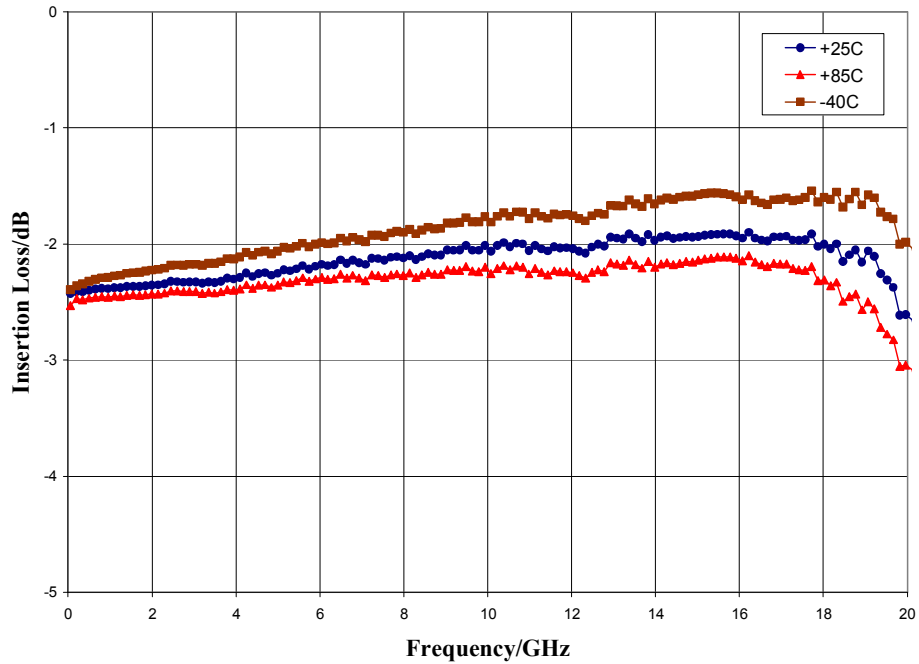
Electrical Specifications - V_{ctl} = 0/-5 V, T_A = 25 °C

| Parameter | Min | Typ | Max | Min | Typ | Max | Units |
|----------------------------------|---------|-----|---------|-----|-----|-----|-------|
| Frequency Range | DC - 12 | | 12 - 18 | | | | GHz |
| Insertion Loss | | 2.4 | 2.8 | | 2.0 | 2.4 | dB |
| Isolation | 40 | 45 | | 32 | 37 | | dB |
| Return Loss - On State | | 13 | | | 15 | | dB |
| Return Loss - RF1, 2 - Off State | | 17 | | | 12 | | dB |
| Input P1dB | | 25 | | | 25 | | dBm |
| Input IP3 | | 38 | | | 40 | | dBm |
| Switching Speed | | 1.8 | | | 1.8 | | ns |

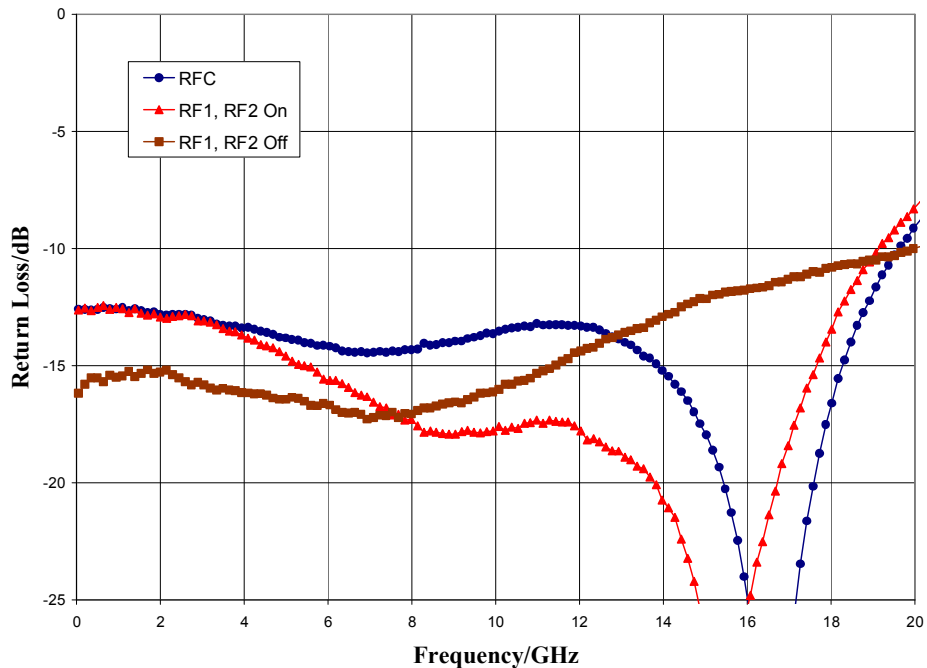
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Typical Performance

Insertion Loss vs. Temperature



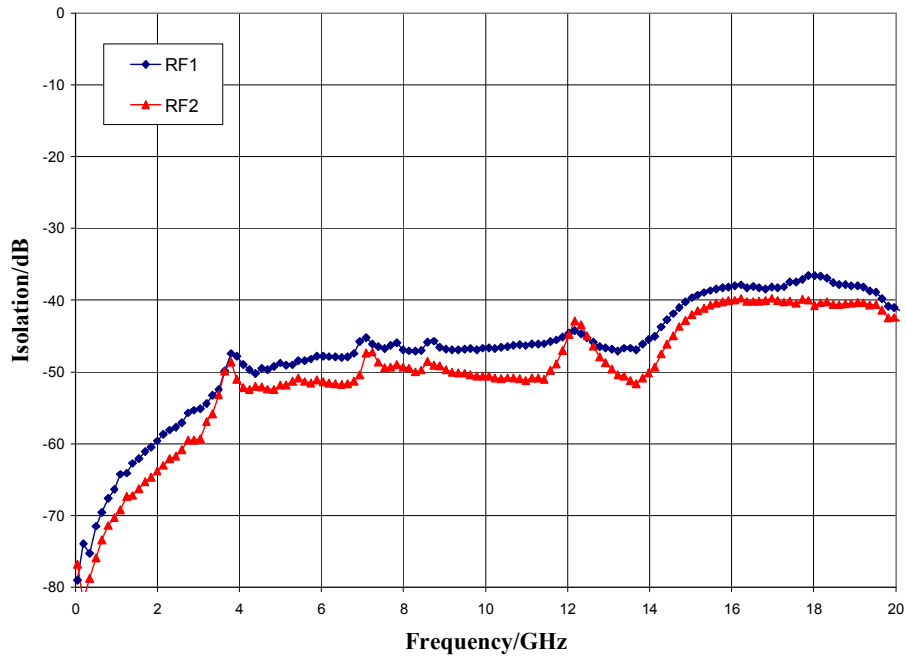
Return Loss



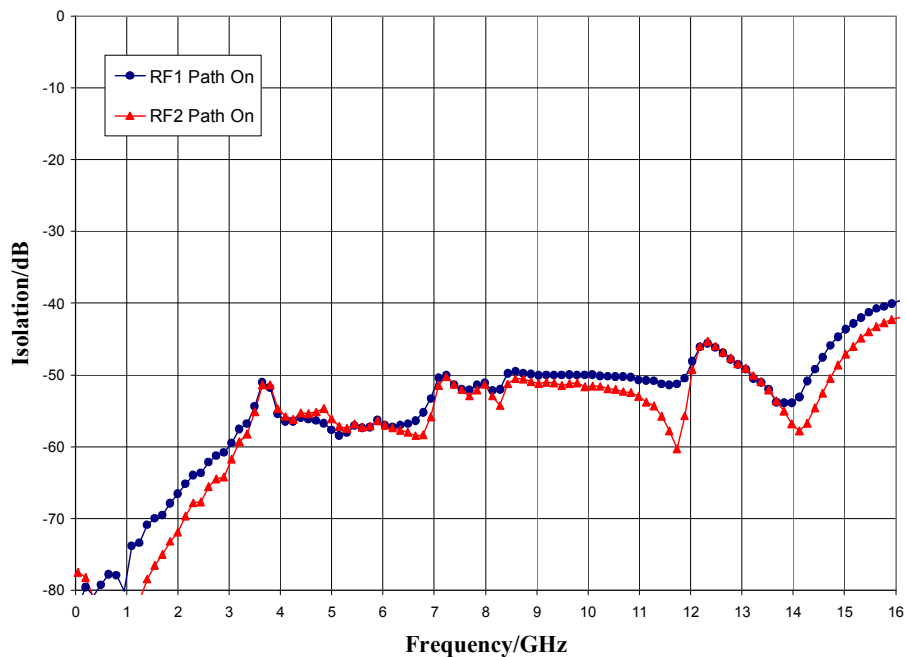
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Typical Performance

Isolation Between Ports RFC and RF1/RF2



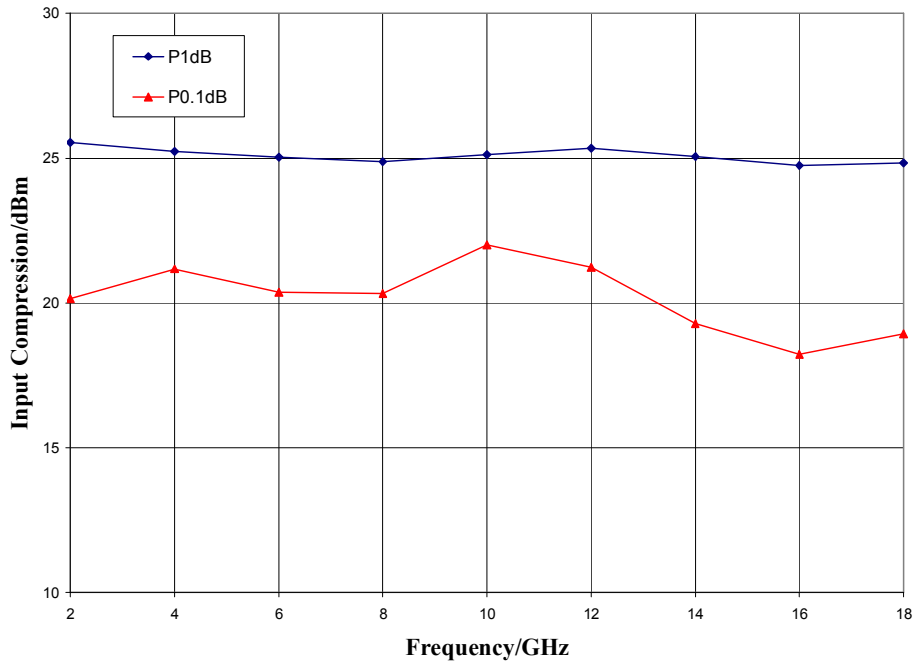
Isolation Between Ports RF1 and RF2



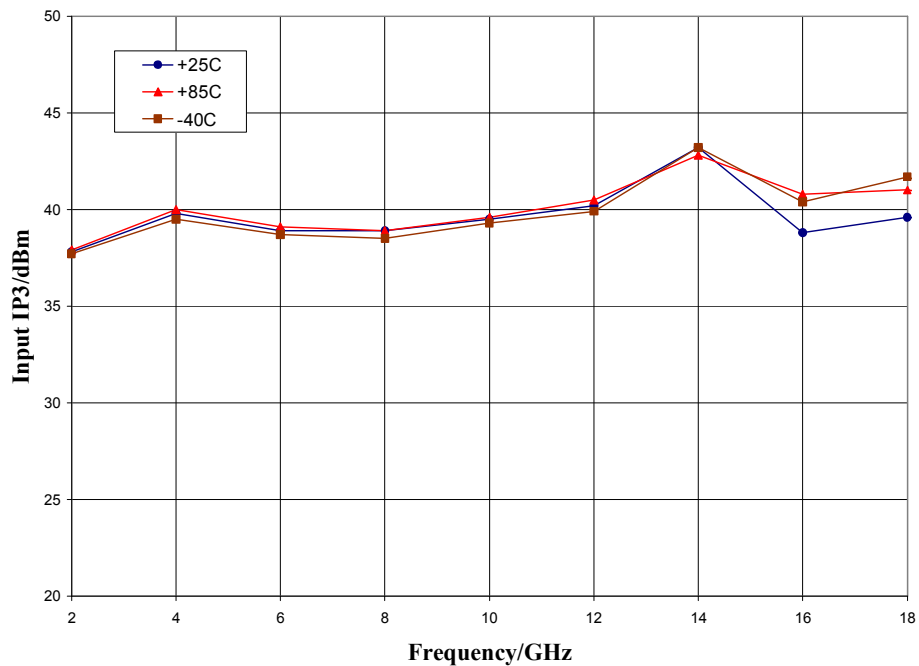
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Typical Performance

Input P1dB and P0.1dB Compression Point



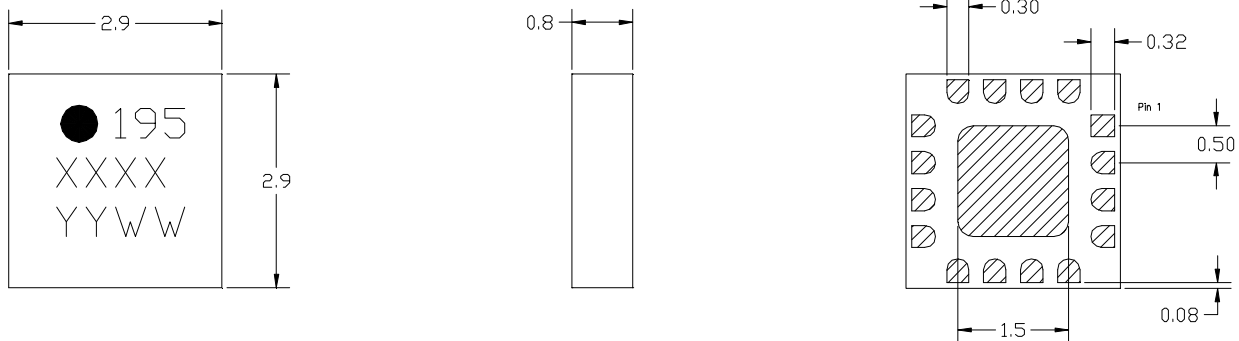
Input Third Order Intercept Point



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Mechanical Information

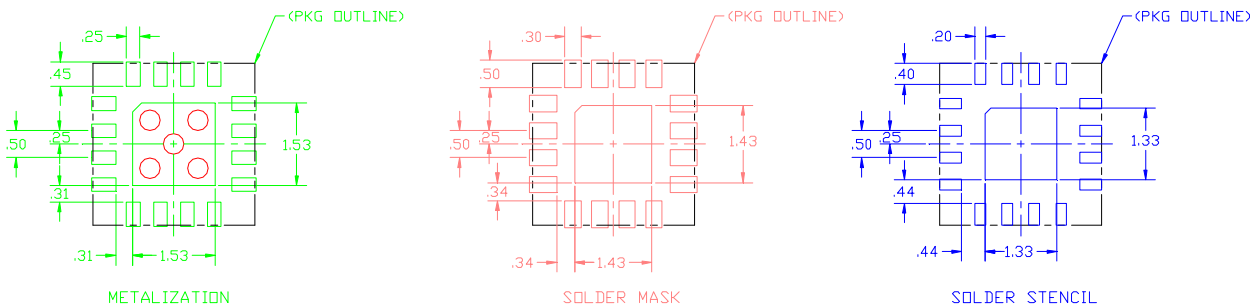
Package Information and Dimensions



NOTES:

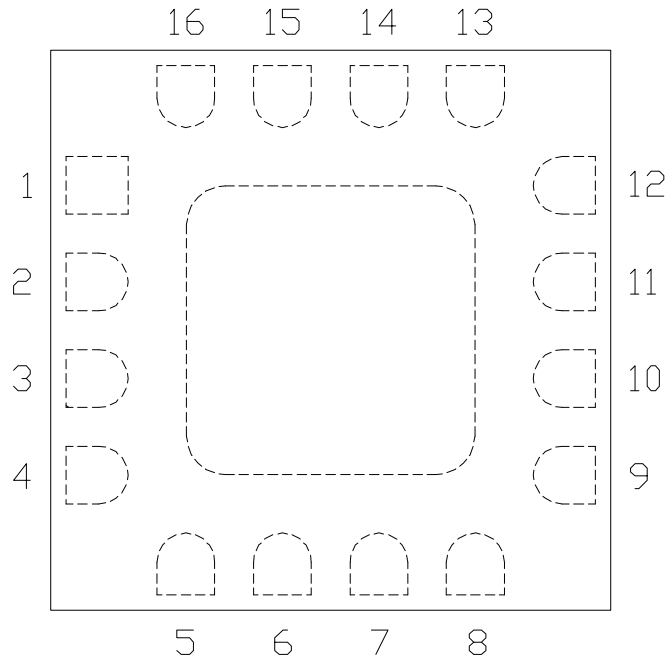
1. DIMENSIONS ARE IN MILLIMETERS
2. MATERIAL: BLACK ALUMINA
3. LEAD FINISH: 30-80 MICRONS GOLD OVER 50 MICRONS NICKEL.
4. ALTERNATE PIN #1 IDENTIFIER IS SINGLE SQUARE PAD.

Recommended PCB Land Pattern


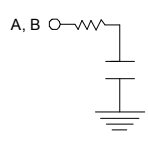


Pin Description

Pin Diagram



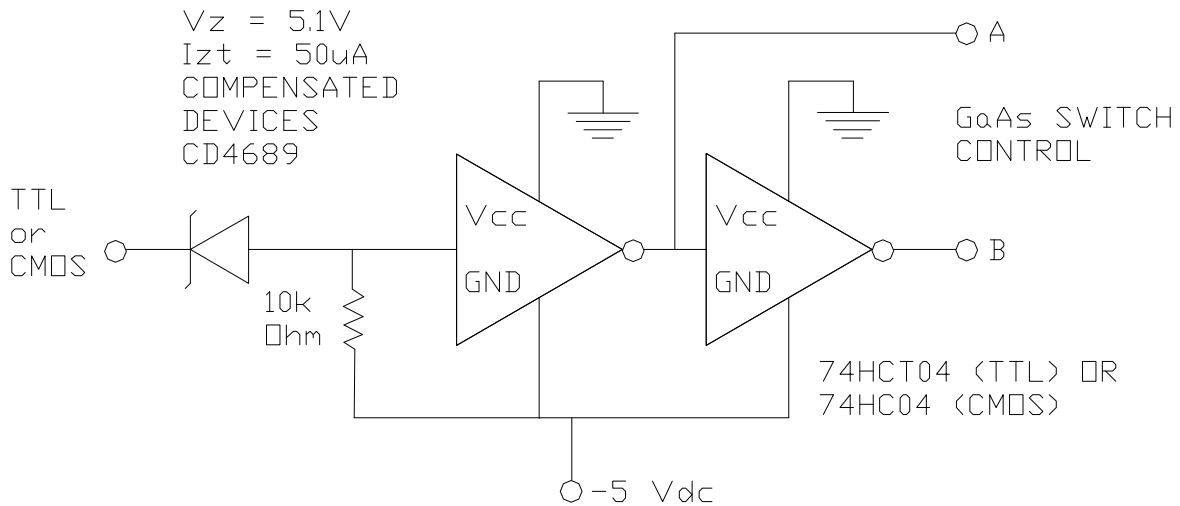
Functional Description

| Pin | Function | Description | Schematic |
|------------------------------|----------|---|---|
| 1,5,9,12,16 | N/C | No connection required. These pins may be connected to RF/DC ground | |
| 2,4,6,8,13,15 and die paddle | Ground | Connect to RF / DC ground |  |
| 3,7,14 | RF1, RF2 | These pins are DC coupled and matched to 50 Ohm. Blocking capacitors are required if RF line potential is not equal to 0V | |
| 10 | CTLB | See truth table and control voltage table |  |
| 11 | CTLA | See truth table and control voltage table | |

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Applications Information

Suggested Driver Circuit



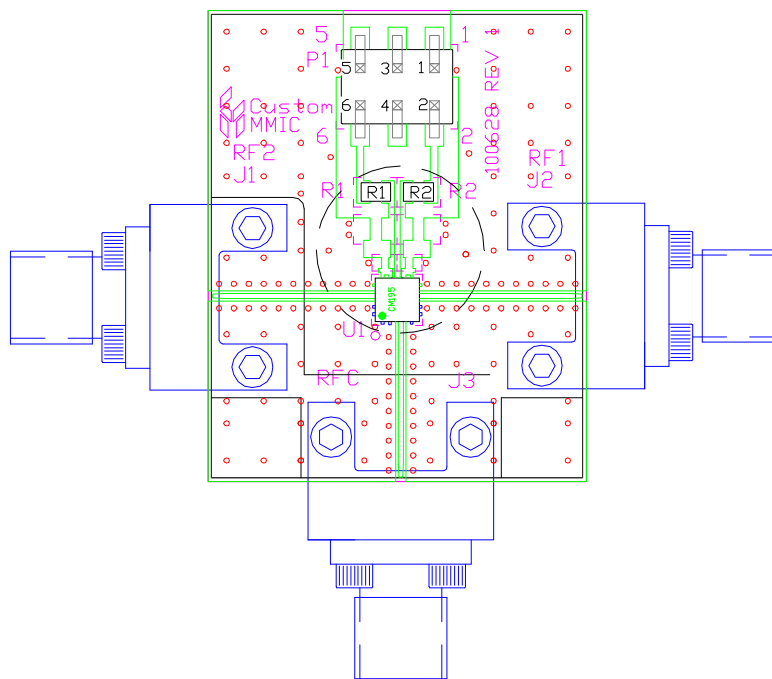
GaAs MMIC devices are susceptible to damage from Electrostatic Discharge. Proper precautions should be observed during handling, assembly and test.

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Applications Information

Evaluation Board

The circuit board shown has been developed for optimized assembly at CMDS. A sufficient number of via holes should be used to connect the top and bottom ground planes. As surface mount processes vary, careful process development is recommended.



Bill of Material

| Designator | Value | Description |
|------------|-------|--------------------------|
| J1, J2, J3 | | SMA End Launch Connector |
| P1 | | 6 Pin Header |
| R1, R2 | 100 Ω | Resistor, 0805 |
| U1 | | CMD195C3 SPDT Switch |
| PCB | | 100628 Evaluation PCB |